

NCE N-Channel Super Trench Power MOSFET

Description

The NCEP40T15GU uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

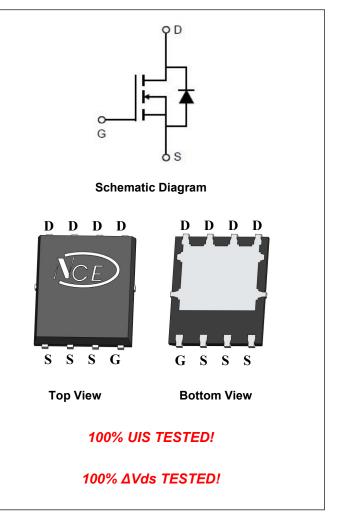
General Features

V_{DS} =40V,I_D =150A
R_{DS(ON)}=1.09mΩ (typical) @ V_{GS}=10V
R_{DS(ON)}=1.5mΩ (typical) @ V_{GS}=4.5V

- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP40T15GU	NCEP40T15GU	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (Tc=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	40	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous (Silicon Limited)	Ι _D	150	A
Drain Current-Continuous(Tc=100 ℃)	I _D (100℃)	106	A
Pulsed Drain Current (Package Limited)	I _{DM}	400	A
Maximum Power Dissipation	PD	135	W
Derating factor		1.1	W/°C
Single pulse avalanche energy (Note 5)	E _{AS}	1500	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	°C

0.93

Thermal Characteristic

Thermal Resistance, Junction-to-Case^(Note 2)

°C/W

Electrical Characteristics (Tc=25 $^\circ\!\!\mathrm{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	40		-	V
Zero Gate Voltage Drain Current	IDSS	V _{DS} =40V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			1			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	1.0	1.5	2.2	V
Desire Oscare On Otate Desiretance	Rds(on)	V _{GS} =10V, I _D =20A	-	1.09	1.35	mΩ
Drain-Source On-State Resistance		V _{GS} =4.5V, I _D =20A	-	1.5	1.85	mΩ
Gate resistance	R _G	V _{DS} =0V,V _{GS} =0V,F=1.0MHz	-	2.0	-	Ω
Forward Transconductance	g fs	V _{DS} =5V,I _D =20A		80	-	S
Dynamic Characteristics (Note4)	·					
Input Capacitance	Clss	- V _{DS} =20V,V _{GS} =0V,	-	5200	6750	PF
Output Capacitance	Coss		-	1700	2210	PF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	85	110	PF
Switching Characteristics (Note 4)	-					
Turn-on Delay Time	t _{d(on)}		-	12	-	nS
Turn-on Rise Time	tr	V _{DD} =20V,I _D =20A V _{GS} =10V,R _G =1.6Ω	-	6.5	-	nS
Turn-Off Delay Time	t _{d(off)}		-	49	-	nS
Turn-Off Fall Time	t _f		-	8	-	nS
Total Gate Charge	Qg		-	91	115	nC
Gate-Source Charge	Q _{gs}	$V_{DS}=20V, I_{D}=20A,$	-	13	17	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	16	20.5	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =75A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	150	A
Reverse Recovery Time	t _{rr}	TJ = 25°C, I⊧ = Is	-		30	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-		110	nC

Rejc

Notes:

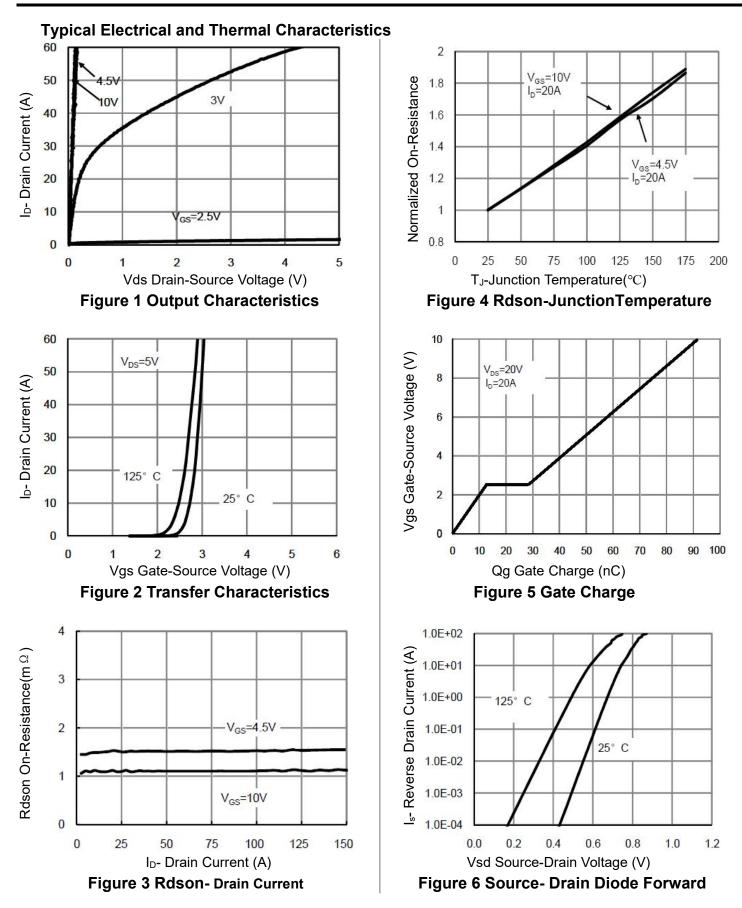
1. Repetitive Rating: Pulse width limited by maximum junction temperature.

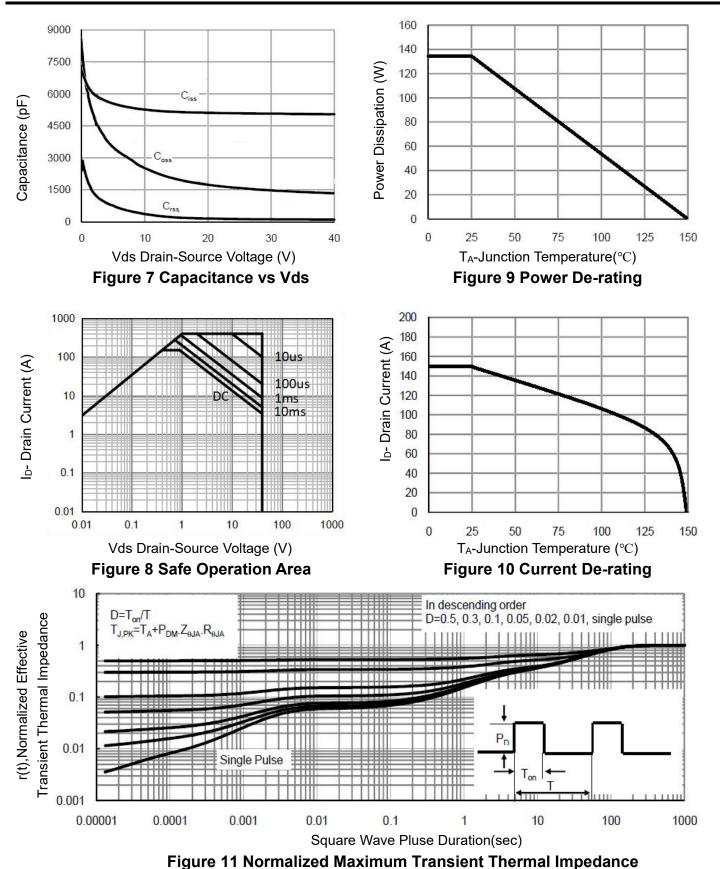
2. Surface Mounted on FR4 Board, t ≤ 10 sec.

3. Pulse Test: Pulse Width ≤ 300 μ s, Duty Cycle ≤ 2%.

4. Guaranteed by design, not subject to production

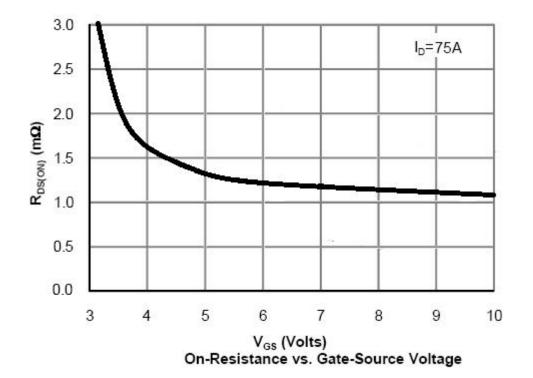
5. EAS condition : Tj=25 $^\circ \! \mathbb{C}$,V_DD=20V,V_G=10V,L=0.5mH,Rg=25 $\! \Omega$



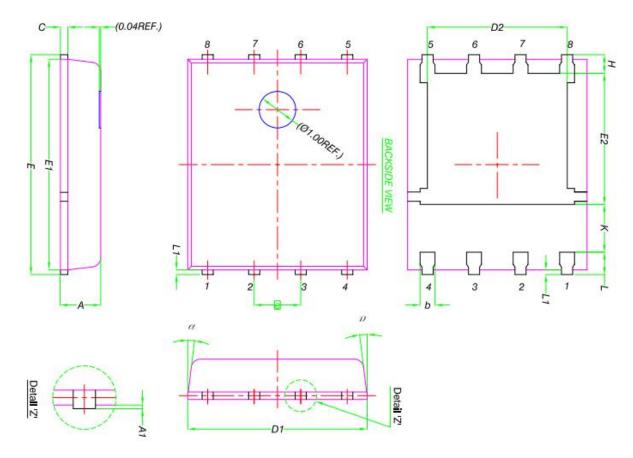


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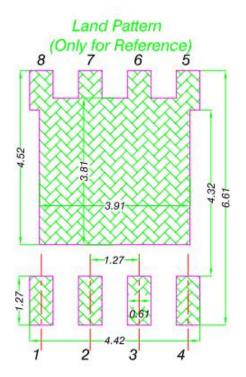
NCEP40T15GU



DFN5X6-8L Package Information



	MILLIMETERS			
DIM.	MIN.	NOM.	MAX.	
А	0.90	1.00	1.10	
A1	0	-	0.05	
b	0.33	0.41	0.51	
С	0.20	0.25	0.30	
D1	4.80	4.90	5.00	
D2	3.61	3.81	3.96	
Ε	5.90	6.00	6.10	
E1	5.70	5.75	5.80	
E2	3.38	3.58	3.78	
е	1.27 BSC			
Н	0.41	0.51	0.61	
K	1.10	-	-	
L	0.51	0.61 0. 0.13 0.		
L1	0.06			
α	0°	- 12	12	



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